

HD74LS01

Quadruple 2-Input Positive NAND Gates (with Open Collector Outputs)

REJ03D0388-0200 Rev.2.00 Feb.18.2005

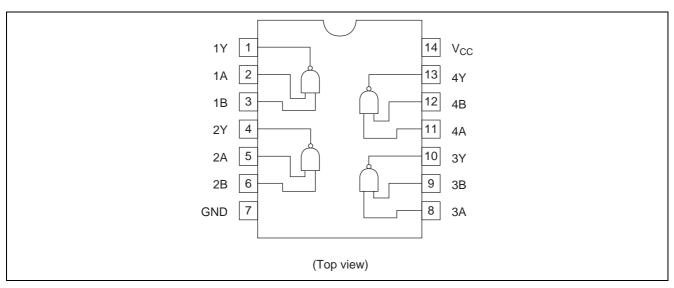
Features

• Ordering Information

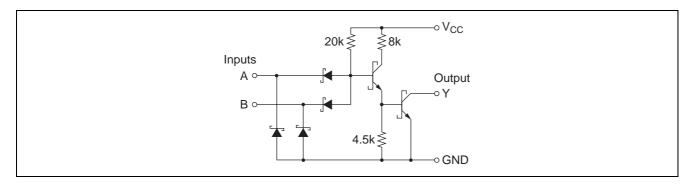
| Part Name | Package Type | Package Code (Previous Code) | Package Abbreviation | Taping Abbreviation (Quantity) |
|--------------|--------------------|---------------------------------|-------------------------|--------------------------------|
| HD74LS01P | DILP-14 pin | PRDP0014AB-B (DP-14AV) | Р | _ |
| HD74LS01FPEL | SOP-14 pin (JEITA) | PRSP0014DF-B (FP-14DAV) | FP | EL (2,000 pcs/reel) |

Note: Please consult the sales office for the above package availability.

Pin Arrangement



Circuit Schematic (1/4)



Absolute Maximum Ratings

| Item | Symbol | Ratings | Unit |
|---------------------|----------------------|-------------|------|
| Supply voltage | V _{CC} Note | 7 | V |
| Input voltage | V _{IN} | 7 | V |
| Power dissipation | P _T | 400 | mW |
| Storage temperature | Tstg | -65 to +150 | °C |

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

| Item | Symbol | Min | Тур | Max | Unit |
|-----------------------|-----------------|------|------|------|------|
| Supply voltage | V _{CC} | 4.75 | 5.00 | 5.25 | V |
| Output voltage | V_{OH} | _ | _ | 5.5 | V |
| Output current | I _{OL} | _ | _ | 8 | mA |
| Operating temperature | Topr | -20 | 25 | 75 | °C |

Electrical Characteristics

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$

| Item | Symbol | min. | typ.* | max. | Unit | Condition | |
|---------------------|------------------|------|-------|------|------|--|--|
| Input voltage | V _{IH} | 2.0 | _ | _ | V | | |
| Input voltage | V_{IL} | _ | _ | 0.8 | V | | |
| Output voltage | V _{OL} | _ | _ | 0.5 | V | $I_{OL} = 8 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V}$ | |
| | | _ | _ | 0.4 | | $I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.73 \text{ V}, \text{ VIH} = 2 \text{ V}$ | |
| Input current | I _{IH} | _ | | 20 | μΑ | $V_{CC} = 5.25 \text{ V}, V_{I} = 2.7 \text{ V}$ | |
| | I_{IL} | _ | | -0.4 | mA | $V_{CC} = 5.25 \text{ V}, V_I = 0.4 \text{ V}$ | |
| | I _I | _ | _ | 0.1 | mA | $V_{CC} = 5.25 \text{ V}, V_{I} = 7 \text{ V}$ | |
| Output current | I _{OH} | _ | _ | 100 | μΑ | $V_{CC} = 4.75 \text{ V}, V_{IL} = 0.8 \text{ V}, V_{OH} = 5.5 \text{ V}$ | |
| Supply current | I _{CCH} | _ | 0.8 | 1.6 | mA | V _{CC} = 5.25 V | |
| | I _{CCL} | _ | 2.4 | 4.4 | mA | V _{CC} = 5.25 V | |
| Input clamp voltage | V_{IK} | _ | _ | -1.5 | V | $V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$ | |

Note: $^*V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$

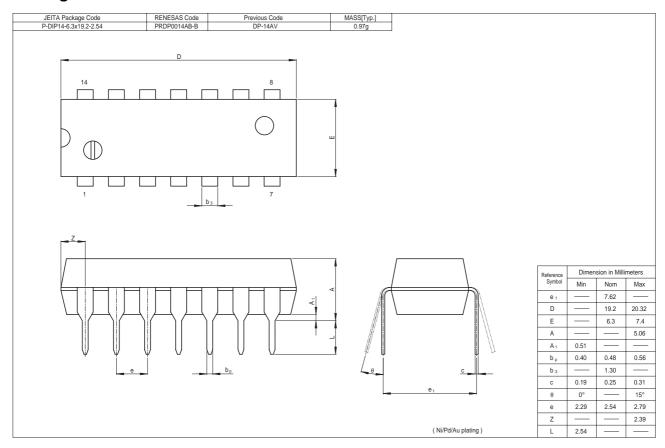
Switching Characteristics

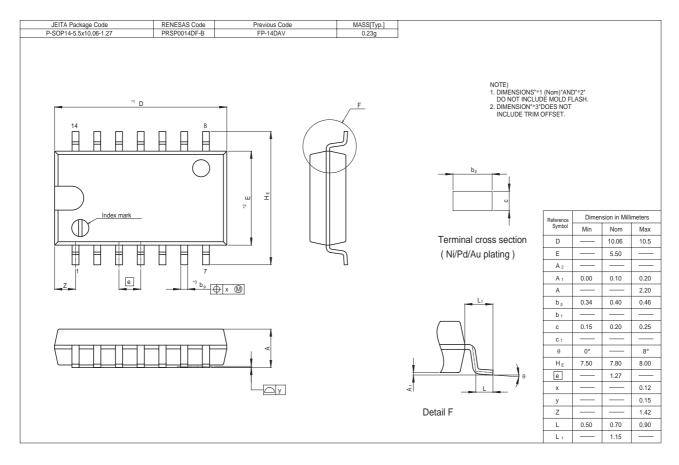
 $(V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C})$

| Item | Symbol | min. | typ. | max. | Unit | Condition |
|------------------------|------------------|------|------|------|------|---|
| Propagation delay time | t _{PLH} | _ | 17 | 32 | ns | $C_1 = 15 \text{ pF}$, $R_1 = 2 \text{ k}\Omega$ |
| | t _{PHL} | _ | 15 | 28 | ns | $C_L = 15 \text{ pF}, R_L = 2 \text{ k}\Omega$ |

Note: Refer to Test Circuit and Waveform of the Common Item "TTL Common Matter (Document No.: REJ27D0005-0100)".

Package Dimensions





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